

MP-A 01

Part No. 3096-0001

Product Specification

Qualification Test Report No. TR-14139

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2	S21556	November 1, 2021	H.Takao	K.Yufu	M.Takemoto	
1	S17460	June 16, 2017	M.N		Ken	
0	S14527	December 19, 2014	T.Hirakawa	K.Yotsutani	T.Takano	
Rev.	ECN	Date	Prepared by	Checked by	Approved by	
Confidential C			I-PEX Inc.		QKE-DFFDE06-08 REV.12	

1. Scope

This product specification defines the test conditions and the performances of the MP-A 01

2. Product Name and Parts No.

2.1 Product Name

MP-A 01

2.2 Parts No.

3096-0001

3. Rating

3.1 Applicable Cable

3.1-1 Cable clamp (3mm) for Φ0.81 coaxial cable (I-PEX P/N: 2296-003)

- 3.1-2 Cable clamp (6mm) for Φ0.81 coaxial cable (I-PEX P/N: 2818-0001)
- 3.1-3 Cable strip (Outer conductor $\Phi 0.85 \pm 0.08$) of $\Phi 0.95$ coaxial cable. $\times 1$
- 3.1-4 Cable jacket (Outside diameter Φ 0.81±0.05) of Φ 0.81 coaxial cable $\times 2$
- 3.1-5 Cable jacket (Outside diameter Φ 0.95±0.05) of Φ 0.95 coaxial cable $\times 1$
 - *1····RF-MF5023 (NISSEI Electric co., ltd)
 - %2···BD-17661 (BANDO Densen co., ltd.)

Note : Only a similar cable is replaceable.

3.2 Operating Conditions

Operating temperature: 233 to 358K(-40°C to 85°C) (Containing temperature rise by current) Operating humidity: 85% max

3.3 Storage Conditions

Storage temperature: 248 to 333K(-25°C to 60°C) Storage humidity: 85% max. (Non-condensing)

4. Test and Performance

Test Condition

Unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature: 288K to 308K(15°C to 35°C) Pressure: 866hPa to 1066hPa(650mmHg to 800mmHg) Relative humidity: 45 to75% R.H.

4.1. Electrical Performance

1. Contact resistance	
Reference standard:	MIL-STD-202-307
Test conditions:	Solder the clip to the test board and mate the test cable together, then apply 20mV MAX. DC open circuit voltage and 10mA MAX. DC closed circuit current. Measure the contact resistance of GROUND at the section shown in Fig.1 by the four terminal methods. Test cable : Chapter 3 (3.1-1, 3.1-2, 3.1-3)
Pass criteria:	Initial: 70 mΩ MAX. After testing: 70 mΩ MAX.

4.2. Mechanical Performance

1. Mating force and Un-r	mating force						
Reference standard:	-						
Test conditions:	Solder the clip to the test board, then place the board and plug on push-on/pull-off machine. Repeat mating/unmating 5 cycles at a speed 25±3mm/min. in direction to show in Fig.2. Measure the mating and unmating force at the initial and after 5cycles.						
	Test cable Vertical Direction Vertical Direction Vertical Direction Mating Un-mating						
Pass criteria:	Mating force Initial: 25 N MAX. 5cycles: 25 N MAX. Unmating force						
	Initial: 3 N MIN. 5cycles: 1.5 N MIN.						
- <u> </u>							
2. Durability							
Reference standard: Test conditions:	- Solder the clip to the test board, then place the board and test cable on the push-on/pull-off machine, and repeat mating and unmating 5cycles at a speed 25±3mm/min. in direction to show in Fig.2.						
Pass criteria:	Contact resistance: Shall meet4.1.1 Appearance: No abnormality adversely affecting the performance shall occur.						
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Test conditions:							
	vibration. During the testing, run 100mA DC to check electrical discontinuity. Frequency: 10Hz \rightarrow 55Hz \rightarrow 10Hz/approx. 1min. Directions: 3 mutually perpendicular directions. Total Amplitude: 1 52mm						

	Sweep duration: 2 hours for each direction, a total of 6 hours.					
Pass criteria:	Contact resistance: Shall meet 4.1.1.					
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.					
	Appearance: No abnormality adversely affecting the performance shall occur.					

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6. Shock	
Reference standard:	MIL-STD-202-213, Test condition A.
Test conditions:	Solder the clip to the test board, then mate test cable, and place them on the shock machine. Then apply the following shock. MAX.G: 50G Duration: 11msec Wave Form: Half Sinusoidal Directions: 6 mutually perpendicular direction Cycle: 3 cycles each direction
Pass criteria:	Contact resistance: Shall meet 4.1.1. Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur. Appearance: No abnormality adversely affecting the performance shall occur.

4.3. Environmental Performance

1. Thermal shock	
Reference standard:	MIL-STD-202-107, Test condition A.
Test conditions:	Solder the clip to the test board, then mate test cable, and expose them to the following environment. Temperature: 218K(-55°C),30min.→358K(85°C),30min. Transition time: 5min. MAX. Cycle: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

2. High temperature life	
Reference standard:	MIL-STD-202-108, Test condition A.
Test conditions:	Solder the clip to the test board, then mate test cable, and expose them to the following environment. Temperature: 358±2K (85±2°C) Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

3. Humidity (Steady state)	
Reference standard:	MIL-STD-202-103, Test condition B.
Test conditions:	Solder the clip to the test board, then mate test cable, and expose them to the following environment. Temperature: 313±2K (40±2°C) Humidity: 90~95%RH Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

4. Low-temperature test	
Reference standard:	IEC-60068-2-1
Test conditions:	Solder the clip to the test board, then mate test cable, and expose them to the following environment. Temperature: $233\pm2K$ (- $40\pm2^{\circ}C$) Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

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4.4. Others

1. Solderability					
Reference stand					
Test conditions:					

 lard:

 Immerse the contact soldering part to flux of RMA type for 5 to 10 seconds, then dip the part into the solder bath of 518±5K (245±5°C) for 5±0.5seconds.

Pass criteria:

More than 95% of the dipped surface shall be evenly wet.



4.5 Test Sequence and Specimen Quantity

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iest tieffi	А	В	С	D	E	F	G	Н	J	K
Contact resistance		1,3	1,3	1,3	1,3	1,3	1,3	1,3		2
Mating force	1,4									
Unmating force	2,5									
Durability	3	2								
Vibration			2							
Shock				2						
Thermal shock					2					
High temperature life						2				
Humidity (Steady State)							2			
Low-temperature test								2		
Solder ability									1	
Soldering heat resistance										1
Specimen quantity.	10	10	5	5	5	5	5	5	5	5

Table.1 Test Sequence and Sample Quantity

XNumbers indicate test sequences.

5. Recommended Metal Mask

Thickness : 0.10mm

